

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Santosh Paul Abraham</td> <td>09/23/2012</td> </tr> <tr> <td>Guido Robert Frederiks</td> <td>09/18/2012</td> </tr> <tr> <td>Simone Merlin</td> <td>09/18/2012</td> </tr> <tr> <td>Maarten Menzo Wentink</td> <td>09/18/2012</td> </tr> </tbody> </table>		Name	Execution Date	Santosh Paul Abraham	09/23/2012	Guido Robert Frederiks	09/18/2012	Simone Merlin	09/18/2012	Maarten Menzo Wentink	09/18/2012		
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<table border="1"> <tr> <td>Name:</td> <td>QUALCOMM Incorporated</td> </tr> <tr> <td>Street Address:</td> <td>5775 Morehouse Drive</td> </tr> <tr> <td>Internal Address:</td> <td>Patent Department/Central Administration</td> </tr> <tr> <td>City:</td> <td>San Diego</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>92121</td> </tr> </table>		Name:	QUALCOMM Incorporated	Street Address:	5775 Morehouse Drive	Internal Address:	Patent Department/Central Administration	City:	San Diego	State/Country:	CALIFORNIA	Postal Code:	92121
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PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13544896</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13544896								
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CORRESPONDENCE DATA													
<p>Fax Number: 8586582502  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 858-845-4265        Email: patent.docketing.us@qualcomm.com        Correspondent Name: QUALCOMM INCORPORATED        Address Line 1: 5775 MOREHOUSE DR.        Address Line 4: SAN DIEGO, CALIFORNIA 92121</p>													
ATTORNEY DOCKET NUMBER:	112733U1												
NAME OF SUBMITTER:	Gina Golia												
Total Attachments: 6													

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**ASSIGNMENT**

WHEREAS, WE,

1. **Santosh Paul Abraham**, a citizen of the **United States of America**, having a mailing address of **5775 Morehouse Drive, San Diego, California, 92121, US**; and a resident of **San Diego, California**;
2. **Guido Robert Frederiks**, a citizen of the **Netherlands**, having a mailing address of **5775 Morehouse Drive, San Diego, California, 92121, US**; and a resident of **Aptos, California**;
3. **Simone Merlin**, a citizen of **Italy**, having a mailing address of **5775 Morehouse Drive, San Diego, California, 92121, US**; and a resident of **San Diego, California**;
4. **Maarten Menzo Wentink**, a citizen of the **Netherlands**, having a mailing address of **5775 Morehouse Drive, San Diego, California, 92121, US**; and a resident of **Breukelen, Netherlands**;

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **SYSTEMS AND METHODS FOR LOW-OVERHEAD WIRELESS BEACONS HAVING COMPRESSED NETWORK IDENTIFIERS** (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at **5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.**, desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). **13/544,896** filed **July 9<sup>th</sup>, 2012**, Qualcomm Reference No. **112733U1** and all provisional applications relating thereto, together with U.S. Provisional Application No(s). **61/506,136**, filed **July 11<sup>th</sup>, 2011**, Qualcomm Reference No. **112733P1**, U.S. Provisional Application No(s). **61/531,522**, filed **September 6<sup>th</sup>, 2011**, Qualcomm Reference No. **112733P2**, U.S. Provisional Application No(s). **61/549,638**, filed **October 20<sup>th</sup>, 2011**, Qualcomm Reference No. **112733P3**, U.S. Provisional Application

No(s). 61/568,075, filed December 7<sup>th</sup>, 2011, Qualcomm Reference No. 112733P4, U.S. Provisional Application No(s). 61/578,027, filed December 20<sup>th</sup>, 2011, Qualcomm Reference No. 112733P5, U.S. Provisional Application No(s). 61/583,890, filed January 6<sup>th</sup>, 2012, Qualcomm Reference No. 112733P6, U.S. Provisional Application No(s). 61/584,174, filed January 6<sup>th</sup>, 2012, Qualcomm Reference No. 112733P7, U.S. Provisional Application No(s). 61/585,044, filed January 10<sup>th</sup>, 2012, Qualcomm Reference No. 112733P8, U.S. Provisional Application No(s). 61/596,106, filed February 7<sup>th</sup>, 2012, Qualcomm Reference No. 112733P9, U.S. Provisional Application No(s). 61/596,775, filed February 9<sup>th</sup>, 2012, Qualcomm Reference No. 112733P10, U.S. Provisional Application No(s). 61/606,175, filed March 2<sup>nd</sup>, 2012, Qualcomm Reference No. 112733P11, U.S. Provisional Application No(s). 61/618,966, filed April 2<sup>nd</sup>, 2012, Qualcomm Reference No. 112733P12, U.S. Provisional Application No(s). 61/620,869, filed April 5<sup>th</sup>, 2012, Qualcomm Reference No. 112733P13 and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;


AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.


Done at San Diego, California on 9/23/2012  
LOCATION DATE

  
Santosh Paul Abraham


Done at Aptos, California on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Guido Robert Frederiks

Done at San Diego, California on 9/13/2012  
LOCATION DATE

  
Simone Merlin

Done at Breukelen, Netherlands on 9/12/2012  
LOCATION DATE

  
Maarten Menzo Wentink

## ASSIGNMENT

WHEREAS, WE,

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WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 13/544,896 filed **July 9<sup>th</sup>, 2012**, Qualcomm Reference No. 112733UI and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/506,136, filed **July 11<sup>th</sup>, 2011**, Qualcomm Reference No. 112733P1, U.S. Provisional Application No(s). 61/531,522, filed **September 6<sup>th</sup>, 2011**, Qualcomm Reference No. 112733P2, U.S. Provisional Application No(s). 61/549,638, filed **October 20<sup>th</sup>, 2011**, Qualcomm Reference No. 112733P3, U.S. Provisional Application

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AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY represent that WE have full and exclusive, unencumbered right to sell, assign, convey and transfer all subject matter herein, and hereby covenant that WE have not and will not execute any writing or do any act whatsoever conflicting with these presents.

Done at <u>San Diego, California</u> on _____	_____ DATE	_____ <b>Santosh Paul Abraham</b>
LOCATION		
Done at <u>Aptos, California</u> on _____	9/18/2012 DATE	_____ <b>Guido Robert Frederiks</b>
LOCATION		
Done at <u>San Diego, California</u> on _____	_____ DATE	_____ <b>Simone Merlin</b>
LOCATION		
Done at <u>Breukelen, Netherlands</u> on _____	_____ DATE	_____ <b>Maarten Menzo Wentink</b>
LOCATION		